DNR-MIL-6







6-Slot, Military-Grade I/O Rack

- Military/Rugged 38999 connectivity
- 100% COTS solution
- Supported by over 80 standard DNR-series I/O boards
- 5 g vibration, 100 g shock, sealed to IP66
- Dual GigE ports (control and diagnostic)
- Designed for MIL-STD-461/810/1275 compliance
- · Extensive built-in system diagnostics
- PowerDNR, UEIPAC, UEISIM & UEIMODBUS configs.
- No rotary cooling devices
- Extensive software support including Windows, Linux, VxWorks, QNX, RTX and more
- VxWorks support available in embedded or hosted configurations.



The new DNR-MIL-6 provides 6 I/O slots and uses standard DNR-series I/O boards (e.g. DNR-AI-217). It is available in the standard PowerDNR configuration or as a UEIPAC, UEISIM, or UEIOPC.

General Description

The DNR-MIL-6 is the latest deployment of UEI's popular RACKtangle® architecture. It is basically a smaller version of UEI's popular DNR-MIL and offers slots for six I/O boards rather than the DNR-MIL's twelve. Designed for use in the toughest environments, the DNR-MIL-6 is ideal for military and aerospace deployments. It is also ideal for a huge assortment of commercial applications including oil drilling platforms and refineries, heavy machinery, outdoor test stands and any other I/O application that will be exposed to the elements. All connectivity is through ROHS compliant 38999 connectors.

Electronically, the DNR-MIL-6 is identical to the standard DNR Series RACKtangle except for hold-up and protection circuitry on the power supply inputs to meet MIL-STD-1275/704.) This means the DNR-MIL-6 uses standard DNR-series boards (e.g. DNR-AI-217 or DNR-1553-553). With over 80 unique I/O boards and 6 slots available there's sure to be a configuration matching your application.

The new DNR-MIL-6 is designed to meet the most commonly required elements of MIL-STD-461 and -810 and is sealed to at least IP66/NEMA6 standards. All this is housed in a compact 10.6" (wide) x 7.0" (tall) x 6.4" (deep) chassis, weighing approximately 16 pounds and typically consuming less than 30 Watts. Heat transfer from the internal electronics to the external chassis is designed such that no fans or rotary cooling is required. The lack of fans maximizes MTBF and mechanical reliability. All internal printed circuit boards are conformal coated to ensure the highest reliability. Heat sink style fins on the top and bottom of the unit ensure the unit will meet its temperature specifications without any forced air cooling, though the unit is also suitable for use with a cold plate if appropriate.

The DNR-MIL-6 is available in different deployment options, including: PowerDNA, UEIPAC, UEISIM and UEIMODBUS.

PowerDNA: DNR-MIL-6

In PowerDNA mode, the RACKtangle operates as a slave I/O device, running under the control of a host PC. All application code in this mode is created and run on the host. PowerDNR mode offers almost unprecedented software support including:

- All popular operating systems including Windows, Linux, VxWorks, QNX, RTX and InTime
- All popular programming languages including VB, VB.NET, C, C#, C++, JAVA
- All popular application packages including MATLAB, Simulink, LabVIEW, and more.

UEIPAC 600-MIL

When deployed as a UEIPAC, the standard firmware running on a RACKtangle is replaced by either a Linux or VxWorks operating system. The user then writes the Linux/VxWorks application that runs on the DNR-MIL-6. In this mode the DNR-MIL-6 can run fully stand-alone, or may be linked to a SCADA host via the Ethernet.

UEISIM 600-MIL

Simulink users will appreciate the ability to build models in Simulink, compile them in Embedded Coder and then deploy them on the UEISIM hardware. It's an ideal platform for testing models on actual hardware. Once the model is proven, it can be deployed using the exact same hardware.

UEIMODBUS 600-MIL

Users needing a compact, rugged Modbus TCP I/O slave will appreciate UEIMODBUS. The rugged, IP66/NEMA6 sealed DNR-MIL-6 allows you to deploy your I/O system in the field, without any additional enclosure and protection.

UEIOPC 600-MIL

The rugged UEIOPC 600-MIL acts as a standalone OPC-UA server (not dependent on Windows), supporting the OPC-UA Historian functionality. System configuration is made easy by an intuitive, easy to use web/HTML interface.

The DNR-MIL-6 platform is 100% COTS, made in the USA and supported by UEI's family of over 80 compatible analog, digital and interface I/O boards, including analog inputs up to 24-bits, thermocouples, RTDs, ICP/IEPE, ARINC-429/453/708, MIL-STD-1553, CAN, RVDT/LVDT, synchro/resolver, RS-232/422/485, strain gauge, quadrature encoder, high-voltage analog outputs (up to 115 VDC) with high drive analog output (up to 200 mA), function generator outputs and more.

Whether your application is on a ship or boat, in an aircraft, in a rocket, on an outdoor test cell, on an oil platform or simply going to be left outside and exposed to the elements, the DNR-MIL-6 is an ideal solution. Of course if you need fewer I/O, you should consider the 4-slot 6.2" x 7.1" x 8.7" DNA-MIL Cube which offers many of the same features and options, but offers slots for up to 4 I/O boards in a smaller chassis. If you need more I/O, please consider the DNR-MIL, which offers identical electronic features, but is larger and provides 12 I/O slots.

Electronic

Technical Specifications

DNR-MIL-6 (Power DNA mode)

Communitary Instanton	DDC: 1C series Circ DACKton also
Computer Interface	PPCx-1G series GigE RACKtangles
Primary Ethernet Port	10/100/1000Base-T, 38999 connector
Diagnostic Port	10/100/1000Base-T, 38999 connector
Config/Serial Port	RS-232, 38999 connector
Sync	1. IEEE-1588/PTP
	2. DNR-SYNC-1G series cables and boards provide both clock and trigger sync signals.
	3 DNR-IRIG-650 board provides IRIG and GPS time synchronization
I/O Board Support	
Series supported	All DNR-series boards
Processor/system	
CPU	Freescale 8347, 400 MHz, 32-bit
Memory (RAM)	256 MB
Memory (Flash)	32 MB
Host Communications	
Distance from host	100 meters max, CAT5/6 cable
Ethernet data transfer rate	20 megabyte per second
Analog data transfer rate	>6 megasample per second. Capable of sustained transfer in any RACKtangle configuration
DMAP/VMAP real-time I/O mode	update >1,000 I/O channels at 4 kHz, guaranteed
Physical Dimensions / Weight	
Physical Dimensions / Weight 6 I/O slots	10.6 "x 7.0" x 6.4"/ 16 lbs. incl I/O boards
	10.6 "x 7.0" x 6.4"/ 16 lbs. incl I/O boards
6 I/O slots	10.6 "x 7.0" x 6.4"/ 16 lbs. incl I/O boards
6 I/O slots Environmental*	
6 I/O slots Environmental* Electrical Isolation	350 Vrms
6 I/O slots Environmental* Electrical Isolation Temp (operating) Temp (storage)	350 Vrms -40 °C to 70 °C -40 °C to 85 °C
6 I/O slots Environmental* Electrical Isolation Temp (operating) Temp (storage) Humidity	350 Vrms -40 °C to 70 °C -40 °C to 85 °C 0 to 95%, non-condensing
6 I/O slots Environmental* Electrical Isolation Temp (operating) Temp (storage) Humidity Vibration	350 Vrms -40 °C to 70 °C -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below
6 I/O slots Environmental* Electrical Isolation Temp (operating) Temp (storage) Humidity Vibration (IEC 60068-2-64)	350 Vrms -40 °C to 70 °C -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5 g (rms), Broad-band random
6 I/O slots Environmental* Electrical Isolation Temp (operating) Temp (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6)	350 Vrms -40 °C to 70 °C -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5 g (rms), Broad-band random 10–500 Hz, 5 g, Sinusoidal
6 I/O slots Environmental* Electrical Isolation Temp (operating) Temp (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6) Shock	350 Vrms -40 °C to 70 °C -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5 g (rms), Broad-band random 10–500 Hz, 5 g, Sinusoidal MIL-STD-810G plus the IEC stds below
6 I/O slots Environmental* Electrical Isolation Temp (operating) Temp (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6)	350 Vrms -40 °C to 70 °C -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5 g (rms), Broad-band random 10–500 Hz, 5 g, Sinusoidal
6 I/O slots Environmental* Electrical Isolation Temp (operating) Temp (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6) Shock	350 Vrms -40 °C to 70 °C -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5 g (rms), Broad-band random 10–500 Hz, 5 g, Sinusoidal MIL-STD-810G plus the IEC stds below 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at
6 I/O slots Environmental* Electrical Isolation Temp (operating) Temp (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6) Shock (IEC 60068-2-27)	350 Vrms -40 °C to 70 °C -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5 g (rms), Broad-band random 10–500 Hz, 5 g, Sinusoidal MIL-STD-810G plus the IEC stds below 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations 70,000 feet, maximum
6 I/O slots Environmental* Electrical Isolation Temp (operating) Temp (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6) Shock (IEC 60068-2-27) Altitude EMI / RFI	350 Vrms -40 °C to 70 °C -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5 g (rms), Broad-band random 10–500 Hz, 5 g, Sinusoidal MIL-STD-810G plus the IEC stds below 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations
6 I/O slots Environmental* Electrical Isolation Temp (operating) Temp (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6) Shock (IEC 60068-2-27)	350 Vrms -40 °C to 70 °C -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5 g (rms), Broad-band random 10–500 Hz, 5 g, Sinusoidal MIL-STD-810G plus the IEC stds below 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations 70,000 feet, maximum
6 I/O slots Environmental* Electrical Isolation Temp (operating) Temp (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6) Shock (IEC 60068-2-7) Altitude EMI / RFI Power Requirements	350 Vrms -40 °C to 70 °C -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5 g (rms), Broad-band random 10–500 Hz, 5 g, Sinusoidal MIL-STD-810G plus the IEC stds below 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations 70,000 feet, maximum Designed to meet MIL-STD-461
6 I/O slots Environmental* Electrical Isolation Temp (operating) Temp (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6) Shock (IEC 60068-2-27) Altitude EMI / RFI Power Requirements Voltage	350 Vrms -40 °C to 70 °C -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5 g (rms), Broad-band random 10–500 Hz, 5 g, Sinusoidal MIL-STD-810G plus the IEC stds below 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations 70,000 feet, maximum Designed to meet MIL-STD-461
6 I/O slots Environmental* Electrical Isolation Temp (operating) Temp (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6) Shock (IEC 60068-2-27) Altitude EMI / RFI Power Requirements Voltage Power	350 Vrms -40 °C to 70 °C -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5 g (rms), Broad-band random 10–500 Hz, 5 g, Sinusoidal MIL-STD-810G plus the IEC stds below 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations 70,000 feet, maximum Designed to meet MIL-STD-461 9 - 36 VDC (115/220 VAC adaptor available) 12 Watts (not including I/O boards)
6 I/O slots Environmental* Electrical Isolation Temp (operating) Temp (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6) Shock (IEC 60068-2-27) Altitude EMI / RFI Power Requirements Voltage Power Power Quality requirement	350 Vrms -40 °C to 70 °C -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5 g (rms), Broad-band random 10–500 Hz, 5 g, Sinusoidal MIL-STD-810G plus the IEC stds below 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations 70,000 feet, maximum Designed to meet MIL-STD-461 9 - 36 VDC (115/220 VAC adaptor available) 12 Watts (not including I/O boards)

Also available in the UEIMODBUS. UEISIM, and UEIOPC-UA Configurations!

UEIPAC 600-MIL

Computer Interface	PPCx-1G series GigE RACKtangles
Primary Ethernet Port	10/100/1000Base-T, 38999 connector
Diagnostic Port*	10/100/1000Base-T, 38999 connector *Alternatively can be teamed/bonded with primary port.
Config/Serial Port	RS-232, 38999 connector
USB Port	USB 2.0 fully supported
Synchronization Options	DNR-SYNC-1G series cables and boards provide both clock and trigger sync signals. DNR-IRIG-650 board provides IRIG and GPS time synchronization PTP client provides software implementation of IEEE-1588
I/O Board Support	
Series supported	All DNR-series boards
Software / Operating System	
Embedded OS	Linux, kernel 4.4.x (VxWorks Available)
Real-time support	Xenomai, Linux RT or VxWorks support
Dev Language	C/C++, Eclipse IDE support,
Dev Environments	Linux PC or Cygwin Windows environment
EPICS CAS interface	Yes
SNMP Library	Yes
OS royalties	none
Processor/system	
CPU	Freescale 8347, 400 MHz, 32-bit
Memory	256 MB (128 MB avail for application SW)
FLASH memory	32 MB (16 MB available for user apps)
Solid State Hard Drive	up to 64 GByte
SD card interface	SD cards up to 32 GB
USB drive interface	Standard USB 2.0 port
Physical Dimensions	10.6% 70% 64% 16% 1 1401
6 I/O slots	10.6 " x 7.0" x 6.4"/ 16 lbs. incl I/O boards
Environmental	2501/200
Electrical Isolation	350 Vrms -40 °C to 70 °C
Temp (operating)	-40 °C to 85 °C
Temp (storage)	
Humidity Vibration	0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below
(IEC 60068-2-64)	10–500 Hz, 5q (rms), Broad-band random
(IEC 60068-2-6)	10–500 Hz, 5 <i>g</i> , Sinusoidal
Shock	MIL-STD-810G plus the IEC stds below
(IEC 60068-2-27)	100 g, 3 ms half sine, 18 shocks at
(120 00000 2 27)	6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations
Altitude	70,000 feet, maximum
EMI / RFI	Designed to meet MIL-STD-461
Power Requirements	
Voltage	9 - 36 VDC (115/220 VAC adaptor available)
Power	12 Watts (not including I/O boards)
Power Quality requirement	Designed to meet MIL-STD-1275
Reliability	
MTBF	100,000 hours

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Technical Specifications

UEISIM 600-MIL

Computer Interface	PPCx-1G series GigE RACKtangles
Primary Ethernet Port	10/100/1000Base-T, 38999 connector
Diagnostic Port	10/100/1000Base-T, 38999 connector
Daisy chain output	n/a
Optional Interface	n/a
Config/Serial Port	RS-232, 38999 connector
USB Port	USB 2.0 fully supported
Sync	DNR-SYNC-1G series cables and boards provide both clock and trigger sync signals
I/O Board Support	
Series supported	All DNR-series boards
Software Requirements	
MATLAB	Version 2007b or greater
Simulink	Version 7.0 or greater
Real-Time Workshop	Version 7.0 or greater
Software / Operating System	
Embedded OS	Linux, kernel 4.4.x, Xenomai RTOS support
Dev Environments	Simulink / Simulink Coder with Cygwin environment on a Windows PC
Processor/system	
CPU	Freescale 8347, 400 MHz, 32-bit
Memory	256 MB (128 MB available for application SW)
Solid State Hard Drive	up to 64 GByte
SD card interface	SD cards up to 32 GB
USB drive interface	Standard USB 2.0 port
Physical Dimensions	
6 I/O slots	10.6 " x 7.0" x 6.4"/ 16 lbs. incl I/O boards
Environmental	
Electrical Isolation	350 Vrms
Temp (operating)	-40 °C to 70 °C
Temp (storage)	-40 °C to 85 °C
Humidity	0 to 95%, non-condensing
Vibration	MIL-STD-810G plus the IEC specs below
(IEC 60068-2-64)	10–500 Hz, 5 <i>g</i> (rms), Broad-band random
(IEC 60068-2-6)	10–500 Hz, 5 <i>g</i> , Sinusoidal
Shock	MIL-STD-810G plus the IEC stds below
(IEC 60068-2-27)	100 g, 3 ms half sine, 18 shocks at 6 orientations;
	30 g, 11 ms half sine, 18 shocks at 6 orientations
Altitude	70,000 feet, maximum
EMI / RFI	Designed to meet MIL-STD-461
Power Requirements	
Voltage	9 - 36 VDC (115/220 VAC adaptor available)
Power	12 Watts (not including I/O boards)
Power Quality requirement	Designed to meet MIL-STD-1275
Reliability	
MTBF	>100,000 hours

Cables, Connectors and screw-terminal panel accessories.

Connectors

All connections to the DNR-MIL-6 are made through standard, COTS, nickel plated 38999 connectors. I/O board connections are made through 128-pin connectors where each I/O board utilizes up to 62 of the 128 pins. The Ethernet, USB, diagnostic Serial, Sync, and hardware reset connections are via 37-pin connectors. Power supply and an auxiliary synch bus connections are through a 13-pin connector.

Cables

Though most customers will design custom cables for their deployed systems, customers working on prototypes and/or those building "one of" systems may desire the ability to connect to the DNR-MIL-6 using more traditional, commercial connections (e.g. RJ-45 for the Ethernet ports).

For these customers UEI offers a complete array of cables and screw terminal panels that will provide direct access to all signals routed in and out of the chassis.

LAN/Power Cables

DNA-CBL-LAN-06 Communications cable

6 foot cable connecting the 37-pin LAN/COM/USB port connector to standard commercial connectors. Ethernet ports come out to RJ-45, the serial port to a DB-9 and the USB ports to standard USB jacks.

DNA-CBL-1315-03 Power supply cable

Connects the 13-pin power/sync connector to a standard female DB-15 connector.

I/O board cables

Each 128 pin I/O 38999 connector provides the I/O connectivity for two I/O slots within the DNR-MIL-6. UEI I/O boards utilize either 37- or 62-pin D connectors and these connectors are mapped as follows.

The left I/O slot (even slot #) maps to pins 1-62 on the 128 pin 38999. The right I/O slot (even slot #) is mapped to pins 65-126 on the 38999. Note that the 37-pin based boards simply do not use pins 38-62. For this reason, most applications can standardize on 62-pin cables and screw terminal panels and simply ignore "no connection" pins. The exception to this is the STP boards that have been specifically designed for use with 37-pin boards (e.g. DNA-STP-207TC). For these boards 37-pin are also available. Also, as some I/O slots may not be utilized in a given application, cables with a single 37-pin or 62-pin D connector are also available.

The following cables provide the same I/O connectivity as the standard, commercial DNA-CBL-37S and DNA-CBL-62 series cables.

DNA-CBL-12862-05: 5 ft male 128-pin 38999 to 2x DB-62M

DNA-CBL-12837-05: 5 ft male 128-pin 38999 to 2x DB-37F

DNA-CBL-6237M-03: 3 ft male RoHS 128-pin 38999 to 1x DB-37F and 1x DB-62M

DNA-CBL-62M-03: 3 ft male 128-pin 38999 to 1x DB-62M

DNA-CBL-37M-03: 3 ft male 128-pin 38999 to 1x DB-37F

Screw Terminal Panels

DNA-STP-37 Standard 37-pin screw terminal panel, suitable for

use with all 37-pin I/O boards and cables.

DNA-STP-62 Standard 62-pin screw terminal panel, suitable for

use with all 62-pin I/O boards and cables.

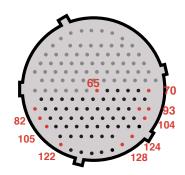
DNA-STP-3762 Standard 37-pin screw terminal panel, providing

both 37- and 62-pin connectors and suitable for use

with any combination of I/O board.

38999 Connector Pinouts

128-pin I/O — mating connector required: D38999/26FJ35PN



Pin#	I/O slot	Board Pin
1	1	1
2	1	2
3	1	3
4	1	4
5	1	5
6	1	6
7	1	7
8	1	8
9	1	9
10	1	10
11	1	11
12	1	12
13	1	13
14	1	14
15	1	15
16	1	16
17	1	17
18	1	18
19	1	19
20	1	20
21	1	21
22	1	22
23	1	23

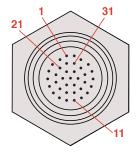
Pin #	I/O slot	Board Pin
24	1	24
25	1	25
26	1	26
27	1	27
28	1	28
29	1	29
30	1	30
31	1	31
32	1	32
33	1	33
34	1	34
35	1	35
36	1	36
37	1	37
38*	1	38
39	1	39
40	1	40
41	1	41
42	1	42
43	1	43
44	1	44
45	1	45
46	1	46

Pin #	I/O slot	Board Pin
47	1	47
48	1	48
49	1	49
50	1	50
51	1	51
52	1	52
53	1	53
54	1	54
55	1	55
56	1	56
57	1	57
58	1	58
59	1	59
60	1	60
61	1	61
62	1	62
63	n/a	n/a
64	n/a	n/a
65	2	1
66	2	2
67	2	3
68	2	4
69	2	5
70	2	6
71	2	7
72	2	8
73	2	9
74	2	10
75	2	11
76	2	12
77	2	13
78	2	14
79	2	15
80	2	16
81	2	17
82	2	18
83	2	19
84	2	20
85	2	21
86	2	22
87	2	23
		*D: 20 (2

Pin#	I/O slot	Board Pin
88	2	24
89	2	25
90	2	26
91	2	27
92	2	28
93	2	29
94	2	30
95	2	31
96	2 2	32
97	2	33
98	2	34
99	2	35
100	2	36
101	2 2	37
102	2	38
103	2	39
104	2	40
105	2	41
106	2	42
107	2	43
108	2	44
109	2	45
110	2 2	46
111	2	47
112	2	48
113	2	49
114	2	50
115	2	51
116	2	52
117	2	53
118	2	54
119	2	55
120	2	56
121	2	57
122	2	58
123	2	59
124	2	60
125	2	61
126	2	62
127		n/a
128	2 2	n/a

*Pins 38-62 are not applicable if I/O slot 1 contains a 37-pin board

37-pin LAN / COM port — mating connector required: D38999/26WD35PN



I III Hullibei	i ili designation
1	LAN0 TX+ / DA+
2	LAN0 RX+ / DB+
3	LAN0 nc / DC-
4	LAN0 nc / DD+
5	Shield
6	Lan1 TX+ / DA+
7	LAN1 RX+ / DB+
8	LAN1 nc / DC-
9	LAN1 nc / DD+
10	Shield
11	Misc In
12	USB1 P+
13	USB1 D+

FIII HUHIDEI	Fill designation
14	USB2 P+
15	USB2 P-
16	USB2 D+
17	USB2 D-
18	LAN0 TX- / DA-
19	LAN0 nc / DC+
20	LAN0 RX- / DB-
21	LAN0 nc / DD-
22	LAN1 TX- / DA-
23	LAN1 nc / DC+
24	LAN1 RX- / DB-
25	LAN1 nc / DD-
26	Misc Out

Pin designation
USB1 P-
USB1 D-
Sync Clock Out
Sync Trig Out
RS232 TX
RS232 RX
RS232 GND
Sync Clock In
Sync Trig In
Sync +5V
Sync Gnd

13-pin power connector— mating connector required: D38999/26FB35PN



	I
Pin #	Pin Designation
1	GND
2	GND
3	GND
4	Vcc (9-36 VDC)
5	Vcc (9-36 VDC)
6	Vcc (9-36 VDC)
7	Sync In2 / reset
8	Sync In0
9	Sync In1
10	Sync Gnd
11	Sync Out1
12	Sync +5V
13	Sync Out0